

12 A Three-quadrant triacs high commutation high temperature

Rev. 01 — 6 April 2007

Product data sheet

1. Product profile

1.1 General description

Passivated, new generation, high commutation, high temperature triacs in a SOT78 plastic package

1.2 Features

- High operating junction temperature
- Very high commutation performance maximized at each gate sensitivity

1.3 Applications

- High temperature, high power motor control - e.g. vacuum cleaners
- Refrigeration and air conditioning compressors
- Heating and cooking appliances

1.4 Quick reference data

- V_{DRM} ≤ 600 V (BTA312-600CT)
- V_{DRM} ≤ 800 V (BTA312-800ET)
- I_{TSM} ≤ 95 A (t = 20 ms)

- Non-linear rectifier-fed motor loads
- Electronic thermostats for heating and cooling loads
- Solid state relays

High immunity to dV/dt

- I_{GT} ≤ 35 mA (BTA312-600CT)
- I_{GT} ≤ 10 mA (BTA312-800ET)
- I_{T(RMS)} ≤ 12 A

SOT78 (TO-220AB)

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)	mb	ν.
2	main terminal 2 (T2)		T2-T1
3	gate (G)		sym051
mb	mounting base; main terminal 2 (T2)		



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3. Ordering information

Table 2. Ordering information							
Type number	Package						
	Name	Description	Version				
BTA312-600CT	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78				
BTA312-800ET		3-lead TO-220AB					

4. Limiting values

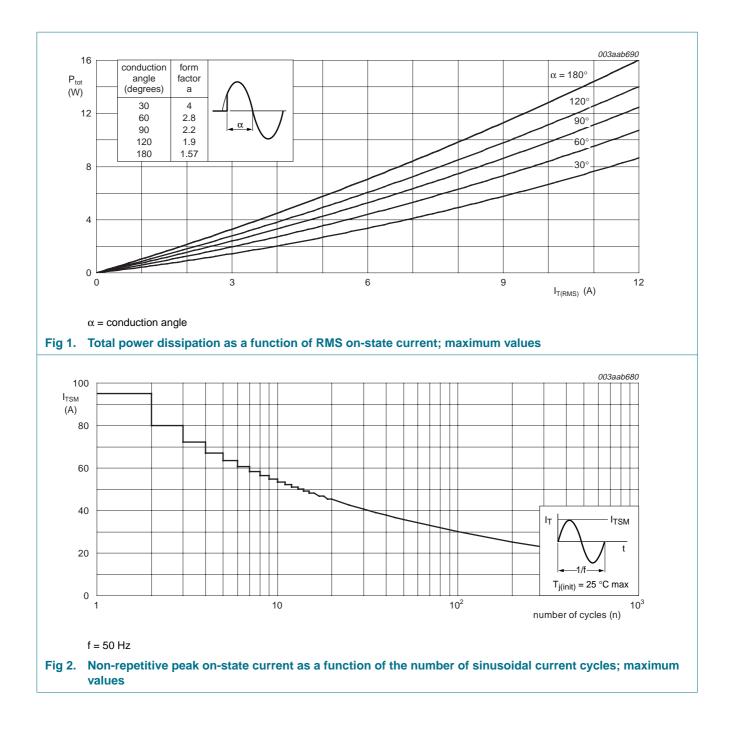
Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

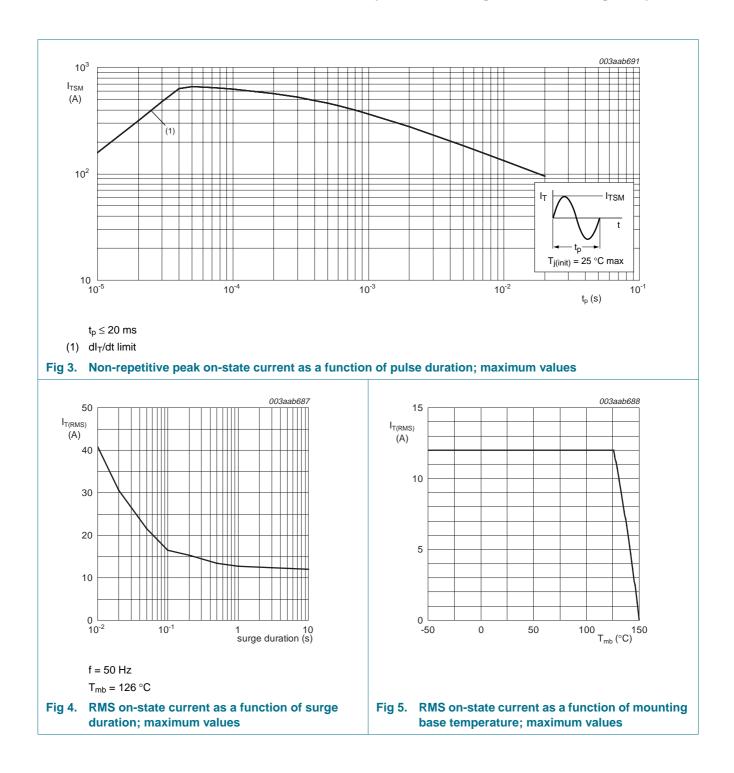
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA312-600CT	<u>[1]</u> -	600	V
		BTA312-800ET	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 126 \text{ °C}$; see Figure 4 and 5	-	12	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	95	А
		t = 16.7 ms	-	105	А
l ² t	I ² t for fusing	t = 10 ms	-	45	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/µs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

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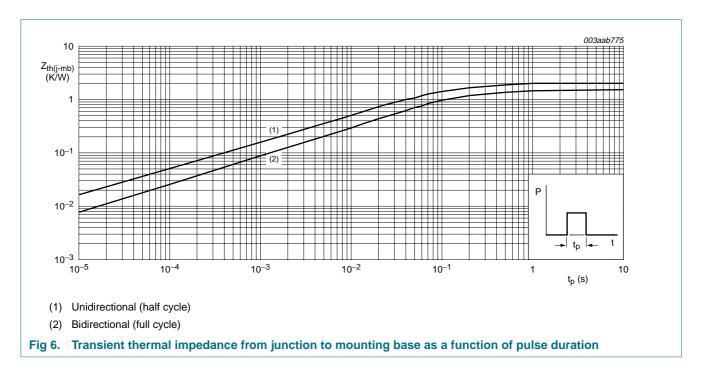


Table

12 A Three-quadrant triacs high commutation high temperature

5. Thermal characteristics

Table 4.	I nermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to	half cycle; see Figure 6	-	-	2.0	K/W
	mounting base	full cycle; see Figure 6	-	-	1.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



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6. Static characteristics

Table 5. Static characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

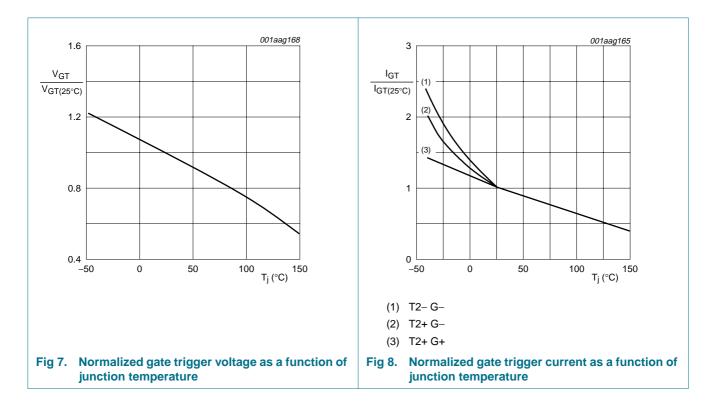
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Symbol	Parameter	Conditions		BTA312-600CT			BTA312-800ET			
			Min	Тур	Max	Min	Тур	Max		
I _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$				·		•	•	
	current	T2+ G+	2	-	35	-	-	10	mA	
		T2+ G-	2	-	35	-	-	10	mA	
		T2- G-	2	-	35	-	-	10	mA	
IL	IL latching current	V_D = 12 V; I_{GT} = 0.1 A; see Figure 10								
		T2+ G+	-	-	50	-	-	25	mA	
		T2+ G-	-	-	60	-	-	30	mA	
		T2-G-	-	-	50	-	-	25	mA	
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 11}}{1000000000000000000000000000000000$	-	-	35	-	-	15	mA	
V _T	on-state voltage	I _T = 15 A; see <u>Figure 9</u>	-	1.3	1.6	-	1.3	1.6	V	
V _{GT}	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.8	1.5	-	0.7	1.5	V	
	voltage	$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 150 ^\circ\text{C}$	0.25	-	-	0.25	-	-	V	
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 150 \ ^{\circ}C$	-	0.4	2	-	0.4	2	mA	

BTA312 series CT and ET

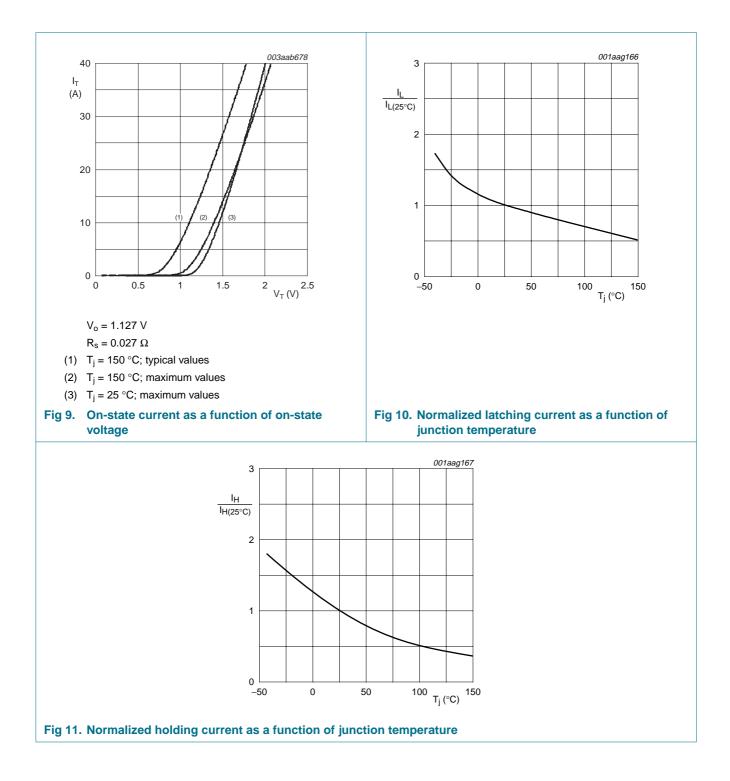
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7. Dynamic characteristics

Table 6.	Dynamic cha	racteristics								
Symbol	Parameter	Conditions		312-60	0CT	BTA	BTA312-800ET			
			Min	Тур	Max	Min	Тур	Max		
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 0.67 × $V_{DRM(max)}$; T_j = 150 °C; exponential waveform; gate open circuit	300	-	-	30	-	-	V/µs	
dl _{com} /dt	rate of change of commutating current	V_{DM} = 400 V; T _j = 150 °C; I _{T(RMS)} = 12 A; without snubber; gate open circuit	8	-	-	2	-	-	A/ms	
		V_{DM} = 400 V; T _j = 150 °C; I _{T(RMS)} = 12 A; dV/dt = 10 V/µs; gate open circuit	13	-	-	3.5	-	-	A/ms	
		V_{DM} = 400 V; T _j = 150 °C; I _{T(RMS)} = 12 A; dV/dt = 1 V/µs; gate open circuit	20	-	-	5	-	-	A/ms	
t _{gt}	gate-controlled turn-on time	I_{TM} = 20 A; V_D = $V_{DRM(max)}$; I_G = 0.1 A; dI_G/dt = 5 A/µs	-	2	-	-	2	-	μs	



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8. Package outline

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DIMENS	I <mark>ONS (n</mark>	nm are t	he origi	nal dime	nsions) c	D	0 止 D 1		huuu	10 mm J	L1	L ₂	q	q	Q	7
mm	4.7	1.40	0.9	1.45	0.7	16.0	6.6	10.3	2.54	15.0	3.30	max. 3.0	3.8	3.0	2.6	-
	4.1	1.25	0.6	1.00	0.4	15.2	5.9	9.7	,	12.8	2.79		3.5	2.7	2.2	
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011	TLINE									-						
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Fig 12. Package outline SOT78 (3-lead TO-220AB)

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9. Revision history

Table 7. Revision hist	Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes				
BTA312_SER_CT_ET_1	20070406	Product data sheet	-	-				

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10. Legal information

10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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NXP Semiconductors

BTA312 series CT and ET

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